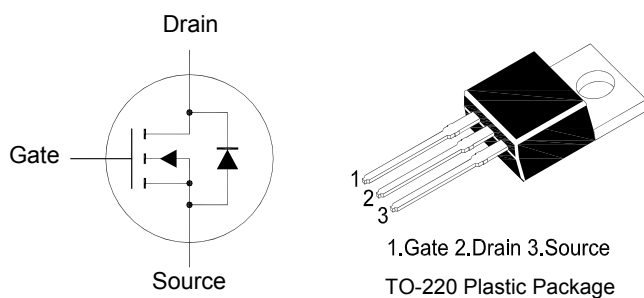


SFTN1210

N-Channel Enhancement Mode Power MOSFET

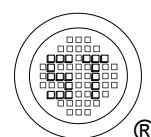


Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	120	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current	I_D	$T_C = 25^\circ\text{C}$ 100	A
		$T_C = 100^\circ\text{C}$ 100	
Peak Drain Current	I_{DM}	400	A
Power Dissipation	P_{tot}	300	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 175	$^\circ\text{C}$

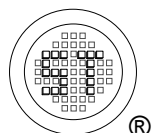
Thermal Characteristics

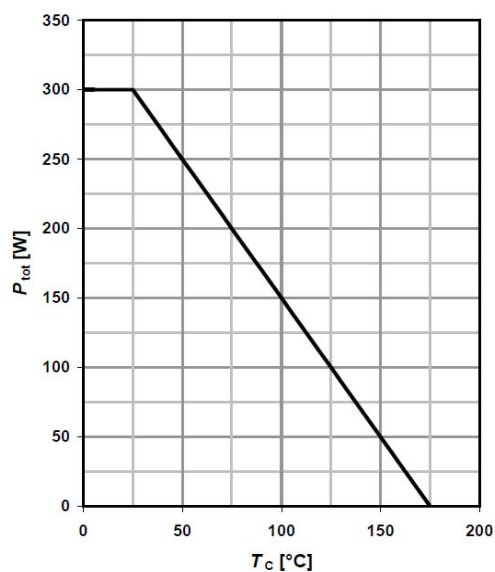
Parameter	Symbol	Max.	Unit
Maximum Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.5	K/W
Maximum Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	62	K/W



Characteristics at $T_J = 25^\circ\text{C}$ unless otherwise specified

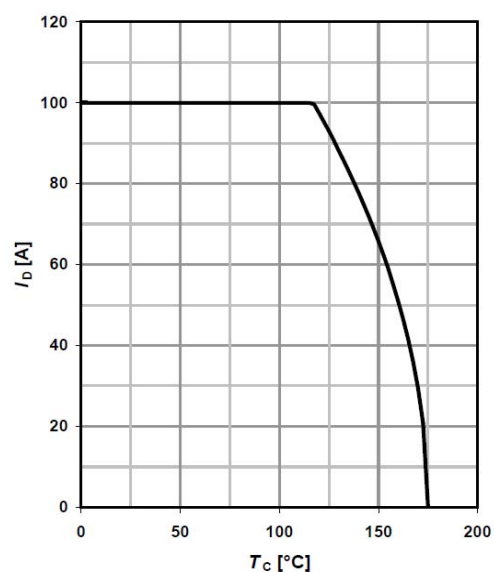
Parameter	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage at $I_D = 1\text{ mA}$	BV_{DSS}	120	-	-	V
Drain-Source Leakage Current at $V_{DS} = 120\text{ V}$ at $V_{DS} = 120\text{ V}$, $T_J = 125^\circ\text{C}$	I_{DSS}	- -	- -	1 100	μA
Gate Leakage Current at $V_{GS} = 20\text{ V}$	I_{GSS}	-	-	100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 230\text{ }\mu\text{A}$	$V_{GS(th)}$	2	-	4	V
Drain-Source On-State Resistance at $V_{GS} = 10\text{ V}$, $I_D = 100\text{ A}$	$R_{DS(on)}$	-	-	4.8	m Ω
Forward Transconductance at $ V_{DS} > 2 \times I_D \times R_{DS(on)max}$, $I_D = 100\text{ A}$	g_{FS}	81	-	-	S
Diode Forward Voltage at $I_F = 100\text{ A}$, $V_{GS} = 0\text{ V}$	V_{SD}	-	-	1.2	V
Maximun Body-Diode Continuous Current	I_S	-	-	100	A
Input Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 60\text{ V}$, $f = 1\text{ MHz}$	C_{iss}	-	-	12000	pF
Output Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 60\text{ V}$, $f = 1\text{ MHz}$	C_{oss}	-	-	1530	pF
Reverse Transfer Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 60\text{ V}$, $f = 1\text{ MHz}$	C_{rss}	-	-	81	pF
Turn-On Delay Time at $I_D = 50\text{ A}$, $V_{DD} = 60\text{ V}$, $V_{GS} = 10\text{ V}$, $R_G = 1.6\text{ }\Omega$	$t_{d(on)}$	-	31	-	ns
Turn-On Rise Time at $I_D = 50\text{ A}$, $V_{DD} = 60\text{ V}$, $V_{GS} = 10\text{ V}$, $R_G = 1.6\text{ }\Omega$	t_r	-	55	-	ns
Turn-Off Delay Time at $I_D = 50\text{ A}$, $V_{DD} = 60\text{ V}$, $V_{GS} = 10\text{ V}$, $R_G = 1.6\text{ }\Omega$	$t_{d(off)}$	-	64	-	ns
Turn-Off Fall Time at $I_D = 50\text{ A}$, $V_{DD} = 60\text{ V}$, $V_{GS} = 10\text{ V}$, $R_G = 1.6\text{ }\Omega$	t_f	-	19	-	ns





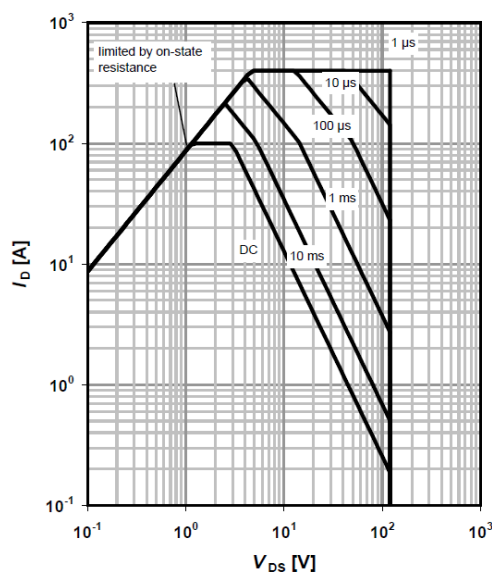
Power dissipation

$$P_{tot} = f(T_c)$$



Drain current

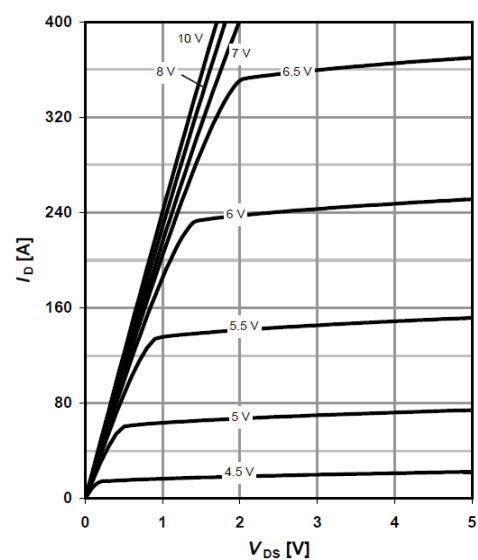
$$I_D = f(T_c); V_{GS} \geq 10 \text{ V}$$



Safe operating area

$$I_D = f(V_{DS}); T_c = 25 \text{ °C}; D = 0$$

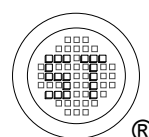
parameter: t_p

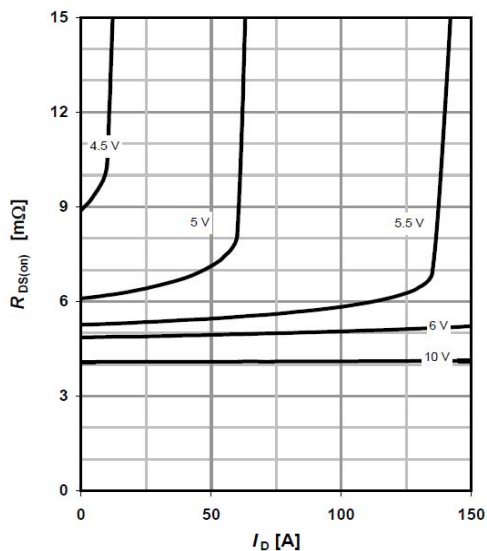


Typ. output characteristics

$$I_D = f(V_{DS}); T_J = 25 \text{ °C}$$

parameter: V_{GS}

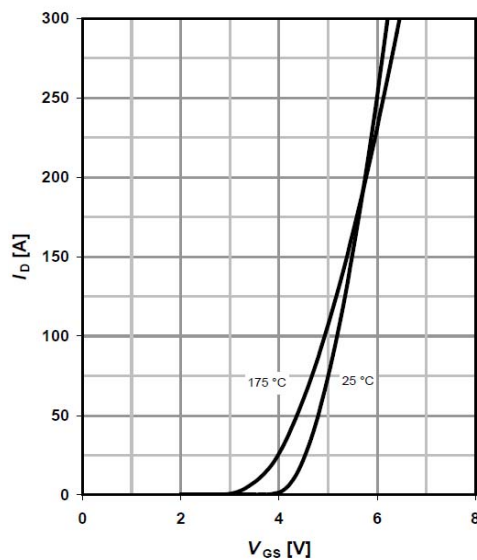




Typ. drain-source on resistance

$$R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}$$

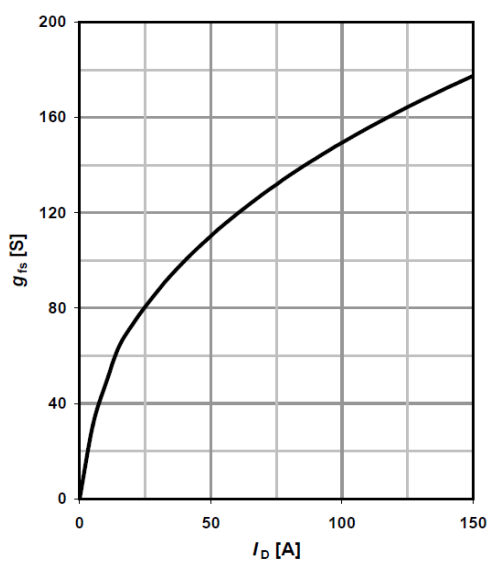
parameter: V_{GS}



Typ. transfer characteristics

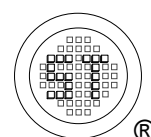
$$I_D = f(V_{GS}); |V_{DS}| > 2|I_D|R_{DS(on)max}$$

parameter: T_j

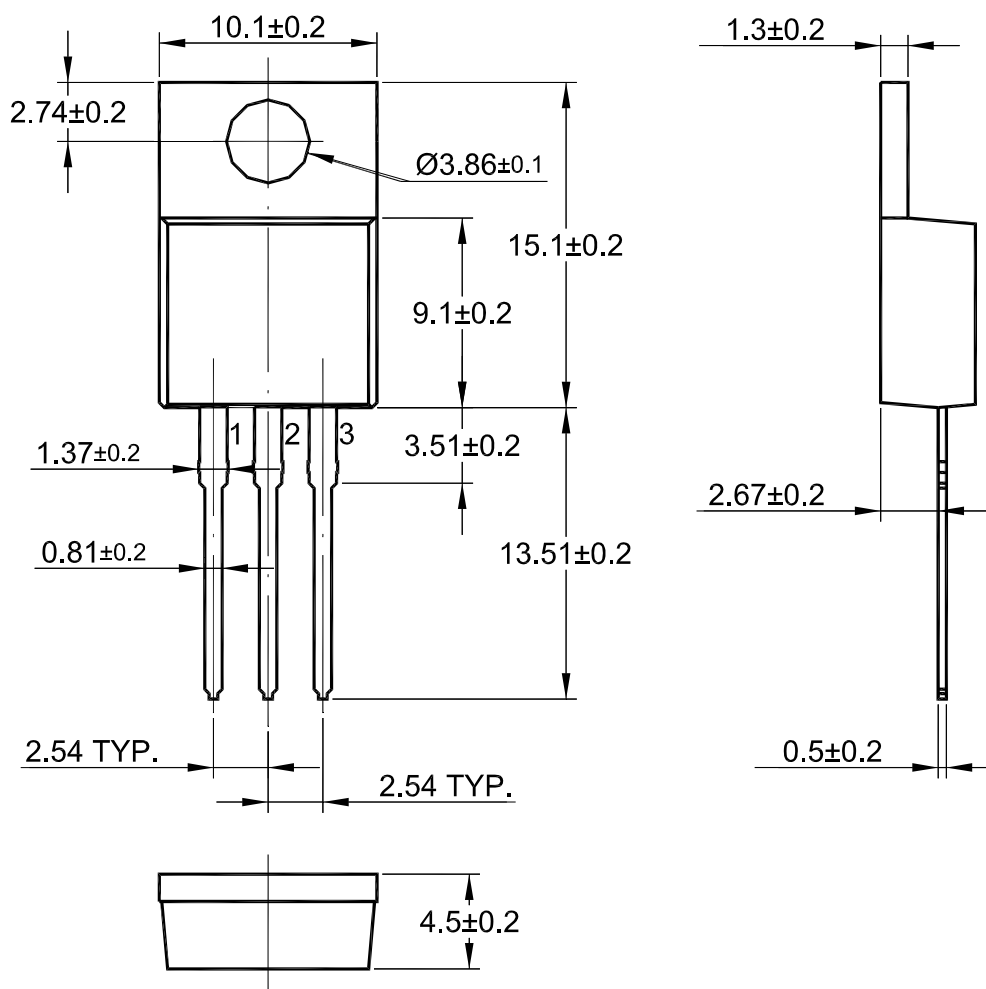


Typ. forward transconductance

$$g_{fs} = f(I_D); T_j = 25^\circ\text{C}$$



TO-220 Package Outline



Dimensions in mm

